





/ Electrical Characteristics(Ta=25 )

| Parameter           | Symbol              | Test Conditions                                                                                    | Min | Typ | Max | Unit |
|---------------------|---------------------|----------------------------------------------------------------------------------------------------|-----|-----|-----|------|
| Turn-On Delay Time  | t <sub>d(on)</sub>  | V <sub>DS</sub> =15 V      V <sub>GS</sub> =10V<br>R <sub>L</sub> =0.75Ω      R <sub>GEN</sub> =3Ω |     | 11  |     | ns   |
| Turn-On Rise Time   | t <sub>r</sub>      |                                                                                                    |     | 14  |     | ns   |
| Turn-Off Delay Time | t <sub>d(off)</sub> |                                                                                                    |     | 38  |     | ns   |
| Turn-Off Fall Time  | t <sub>f</sub>      |                                                                                                    |     | 10  |     | ns   |

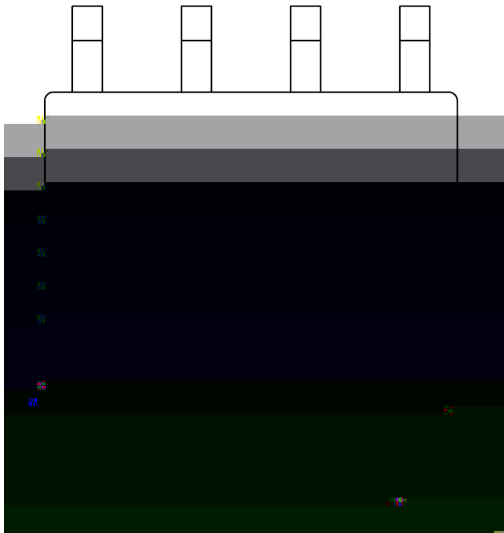


**/ Electrical Characteristic Curve**



/ Package Dimensions





(     ) / Temperature Profile for IR Reflow Soldering(Pb-Free)

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备注

- 1    预热 150℃~180℃，时间 60~90sec;
- 2    峰值温度 245℃±5℃，持续时间 5~0.5sec;
- 3    冷却速度 2~10℃/sec.

Note:

- 1.Preheating:150~180℃，Time:60~90sec.
- 2.Peak Temp.:245℃±5℃，Duration:5~0.5sec.
3. Cooling Speed: 2~10℃/sec.

/ Resistance to Soldering Heat Test Conditions

605℃±5℃